

Appl. No. 10/773,088
Amtd. Dated April 17, 2006

Attorney Docket No. 81784.0301
Customer No. 26021

Reply to Office Action of December 21, 2005



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:
Mitsuru OKIGAWA
Serial No.: 10/773,088
Confirmation No.: 3288
Filed: February 5, 2004
For: SEMICONDUCTOR INTEGRATED
DEVICE INCLUDING SUPPORT
SUBSTRATE FASTENED USING
RESIN, AND MANUFACTURING
METHOD THEREOF

Art Unit: 2891
Examiner: Luan C. Thai

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to:	
Mail Stop RCE Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450	
April 17, 2006	Date of Deposit
John P. Scherlacher, Reg. No. 23,009	
Name	04/17/06
Signature	Date

AMENDMENT

Mail Stop RCE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In conjunction with the Request for Continued Examination (RCE) being filed concurrently herewith, and in response to the Final Office Action of December 21, 2005, the period for response to which has been extended by the enclosed Petition to April 21, 2006, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 4 of this paper.